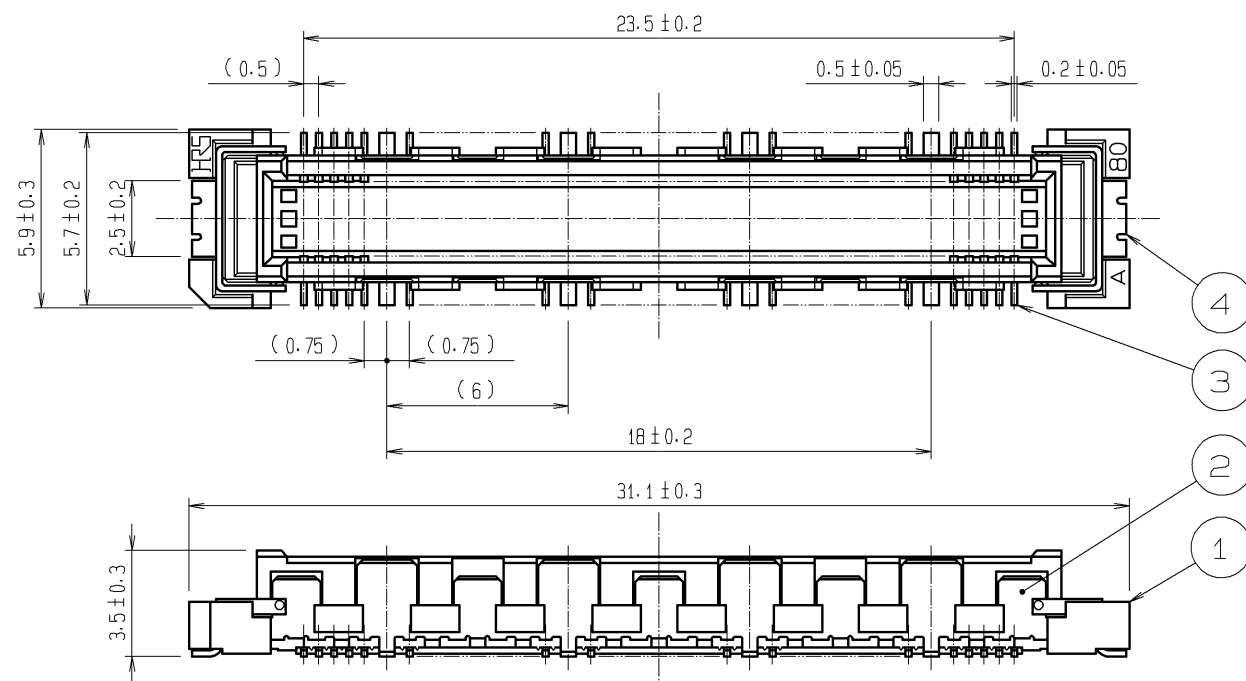
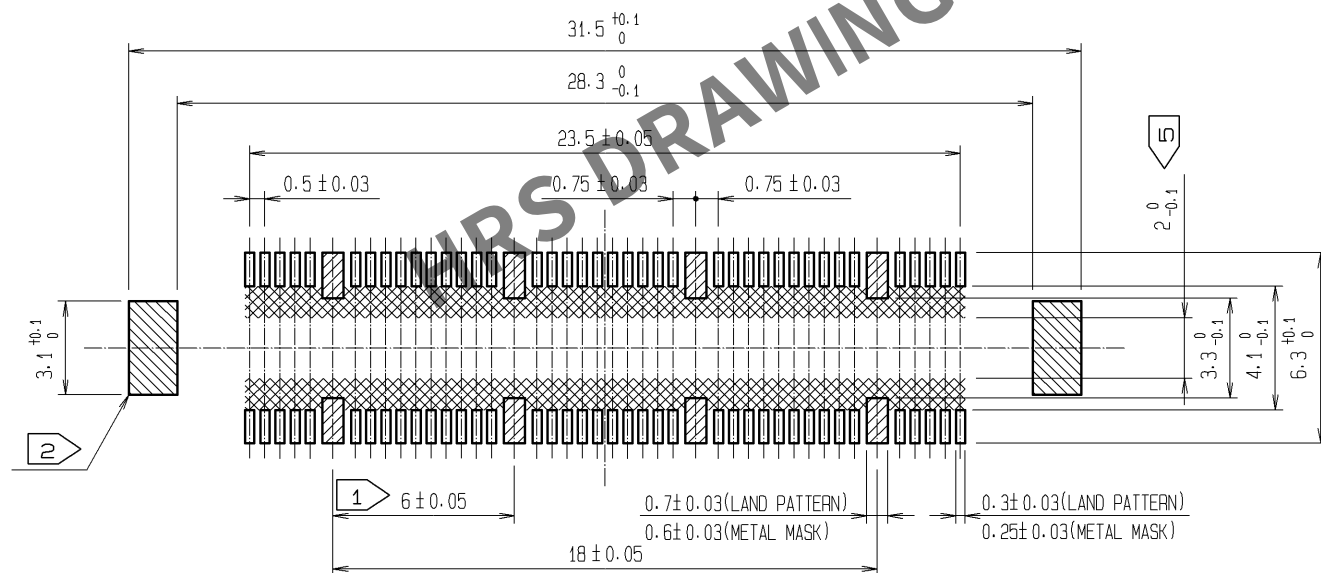
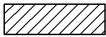


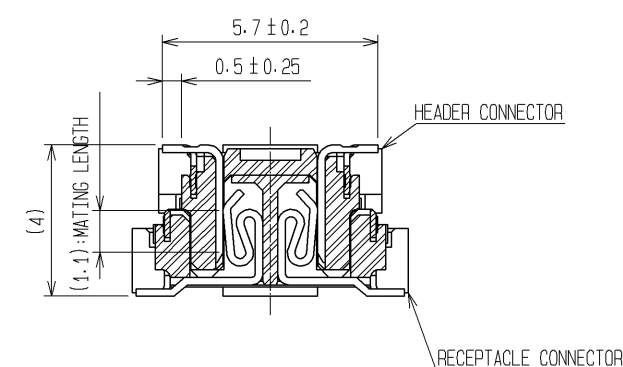


RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)

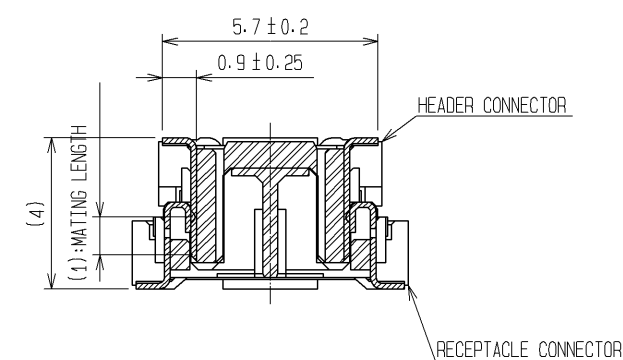


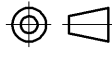
- NOTES
- ① 8 HATCHED  PARTS: GROUND CIRCUIT.
 - ② 2 HATCHED  PARTS: GROUND CIRCUIT.
 - 3 SMT LEAD-COPLANARITY: 0.1 MAX.
 - 4 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED  AREA.)
 - 6 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

CROSS CUT SECTION - SIGNAL (5:1)



CROSS CUT SECTION - GROUND (5:1)



2	PHOSPHOR BRONZE	TIN-PLATING	3	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min.					
1	LCP	BEIGE UL94V-0			LEAD AREA : TIN-PLATING 1μm min.					
					UNDER PLATING : NICKEL 1μm min.					
NO.	MATERIAL	FINISH, REMARKS		NO.	MATERIAL	FINISH, REMARKS				
UNITS mm			SCALE 4 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA		08.06.26		DRAWING NO.		EDC3-151948-25		
		CHECED : HT. YAMAGUCHI		08.06.25		PART NO.		FX10B-80P/8-SV(71)		
		DESIGNED : SY. KAMIGA		08.06.23		CODE NO.		CL570-0021-2-71		
		DRAWN : HK. SUNADORI		08.06.17				 1/1		